

RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)

SPECIFICATIONS

Rated Current:0.75AMP

Contact Resistance:30m Ω Max

Withstand Voltage:500V AC/DC

Insulation Resistance:1000M Ω Min

Operation Temperature:-40°C to +105°C

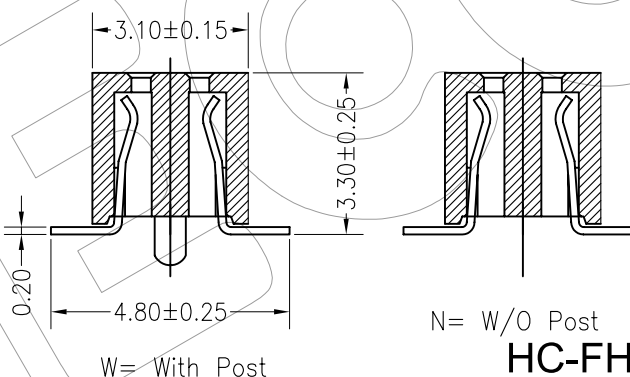
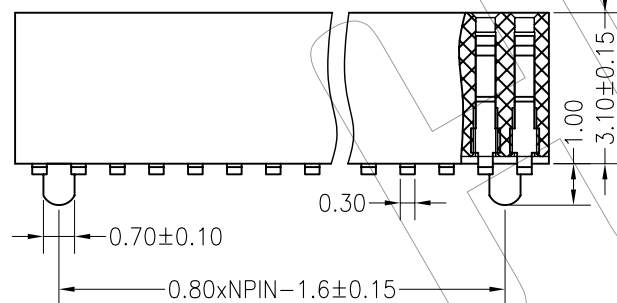
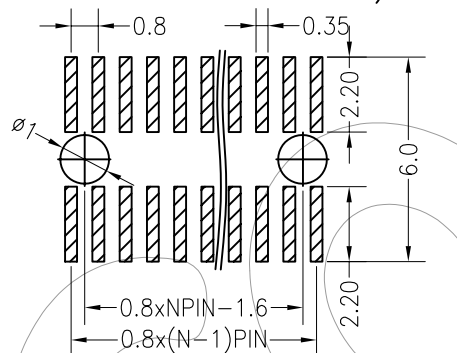
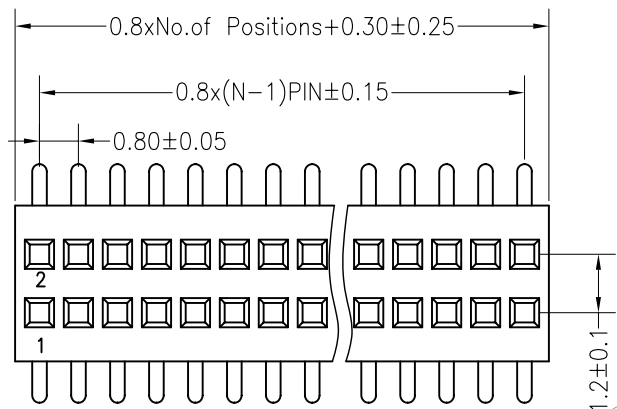
Contact Material:Phosphor Bronze

Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: LCP

Max.Processing Temp: 240°C for 30-60 seconds
(260°C for 10 seconds)



N= W/O Post

W= With Post

Ordering Information

HC-FH931 02 XX X X XX M U X 01

No.of
Pins
Per Row
2*50

Insulator Material
Option
A=BK-PBT
B=BK-PA66
C=BK-PA6T
D=BK-PA46
F=BK-LCP

Post
W=With Post
N=W/O Post

Contact Plating
G0:Gold Flash
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
0=PE Bag
A=Tray
T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar

OPERATION

X.X ± 0.30

X.XX ± 0.20

X.XXX ± 0.10

Angle $\pm 3^\circ$

DIM TOL

DRAW

Ayang

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

1/1

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-FH93102XXXXXXMUX01

TITLE:

0.8mm H3.1 Dual Row SMT Female Header

A0

REV

DATE

MODIFICATION DESCRIPTION

CHANGE

1

2

3

4

5

6

7

8

9